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Part Number: 0878312420

Status: Active
Overview: milligrid

Description: 2.00mm (.079") Pitch Milli-Grid™ Header, Vertical, Through Hole, Shrouded, Lead-free,

24 Circuits, 0.38µm (15µ") Gold (Au) Plating, Center Polarization Slot, with Locking

Windows, without PCB Locator, Tube

Documents:

3D Model Product Specification PS-87831-027 (PDF)
Drawing (PDF) RoHS Certificate of Compliance (PDF)

Agency Certification

CSA LR19980 UL E29179

General

Product Family PCB Headers Series 87831

Application Signal, Wire-to-Board

Comments Contact Molex for application in automotive industry

Physical

No Breakaway Circuits (Loaded) 24 Circuits (maximum) 24 Color - Resin Black First Mate / Last Break No Flammability 94V-0 Glow-Wire Compliant No Guide to Mating Part No Keying to Mating Part None Lock to Mating Part Yes

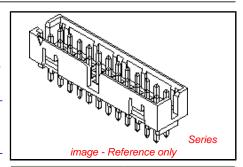
Material - Metal Brass, Phosphor Bronze

Material - Plating MatingGoldMaterial - Plating TerminationTinMaterial - ResinNylonNumber of Rows2OrientationVerticalPC Tail Length2.50mm (.098")

PCB Locator No **PCB** Retention None PCB Thickness - Recommended 1.60mm (.063") Tube Packaging Type Pitch - Mating Interface 2.00mm (.079") Pitch - Termination Interface 2.00mm (.079") Plating min - Mating 0.381µm (15µ") Plating min - Termination 1.905µm (75µ") Polarized to Mating Part Side Slots (2)

Polarized to PCB No
Shrouded Fully
Stackable No
Surface Mount Compatible (SMC) Yes

Temperature Range - Operating -55°C to +105°C



EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Low-Halogen Status
Not Low-Halogen



China RoHS

Need more information on product environmental compliance?

Email <u>productcompliance@molex.com</u>
For a multiple part number RoHS Certificate of Compliance, <u>click here</u>

Please visit the <u>Contact Us</u> section for any non-product compliance questions.

Search Parts in this Series

87831 Series

Mates With

50394 Wire-to-Board Terminals. 51110 Wire-to-Board Crimp Housing. 87568 Wire-to-Board IDT Housings. 79107 Board-to-Board Top Entry Through Hole Receptacle. 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle. L

Termination Interface: Style Through Hole

Electrical

Current - Maximum per Contact 2A Voltage - Maximum 125V

Solder Process Data

Duration at Max. Process Temperature (seconds) 10

Lead-free Process Capability Wave Capable (TH only)
Max. Cycles at Max. Process Temperature 1

Process Temperature max. C 260

Material Info

Country of Origin SG

Reference - Drawing Numbers

Product Specification PS-87831-027 Sales Drawing SD-87831-011

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